

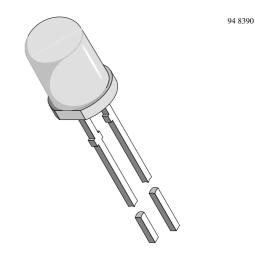
GaAs/GaAlAs IR Emitting Diodes in ø 5mm (T-1¾) Package

Description

TSIP 52..-series are high efficiency infrared emitting diodes in GaAlAs on GaAs technology, molded in clear, bluegrey tinted plastic packages.

In comparison with the standard GaAs on GaAs technology these emitters achieve about 70 % radiant power improvement at the same wavelength.

The forward voltages at low current and at high pulse current roughly correspond to the low values of the standard technology. Therefore these emitters are ideally suitable as high performance replacements of standard emitters. It is not necessary to modify the filter characteristics of the detector, the cover plates of transmitter and receiver or the supply voltage.



Features

- Extra high radiant power and radiant intensity
- Low forward voltage
- Suitable for DC and high pulse current operation
- Standard T–1³/₄ (ø 5 mm) package
- Angle of half intensity $\varphi = \pm 17^{\circ}$
- Peak wavelength $\lambda_p = 950 \text{ nm}$
- High reliability
- Good spectral matching to Si photodetectors

Applications

Infrared remote control units with high power requirements Free air transmission systems Infrared source for optical counters and card readers IR source for smoke detectors



Absolute Maximum Ratings

 $T_{amb} = 25^{\circ}C$

Parameter	Test Conditions	Symbol	Value	Unit
Reverse Voltage		V_R	7	V
Forward Current		I_{F}	150	mA
Peak Forward Current	$t_p/T=0.5, t_p=100 \mu s$	I_{FM}	300	mA
Surge Forward Current	t _p =100 μs	I _{FSM}	3	A
Power Dissipation		P_V	210	mW
Junction Temperature		T_j	100	°C
Operating Temperature Range		T _{amb}	-55 + 100	°C
Storage Temperature Range		T_{stg}	-55 + 100	°C
Soldering Temperature	$t \le 5 \text{sec}, 2 \text{ mm from case}$	T _{sd}	260	°C
Thermal Resistance Junction/Ambient		R_{thJA}	350	K/W

Basic Characteristics

 $T_{amb} = 25^{\circ}C$

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Forward Voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	$V_{\rm F}$		1.3	1.8	V
	$I_F = 1.5 \text{ A}, t_p = 100 \mu\text{s}$	V_{F}		2.4	3.2	V
Temp. Coefficient of V _F	$I_F = 100 \text{mA}$	TK _{VF}		-1.3		mV/K
Reverse Current	$V_R = 5 V$	I_R			100	μA
Junction Capacitance	$V_R = 0 \text{ V, } f = 1 \text{ MHz, } E = 0$	Cj		30		pF
Temp. Coefficient of φ _e	$I_F = 20 \text{ mA}$	TKφe		-0.8		%/K
Angle of Half Intensity		φ		±17		deg
Peak Wavelength	$I_F = 100 \text{ mA}$	λ_{p}		950		nm
Spectral Bandwidth	$I_F = 100 \text{ mA}$	Δλ		50		nm
Temp. Coefficient of λ_p	$I_F = 100 \text{ mA}$	ТКλр		0.2		nm/K
Rise Time	$I_F = 100 \text{ mA}$	t _r		800		ns
	$I_F = 1.5 \text{ A}$	t _r		500		ns
Fall Time	$I_F = 100 \text{ mA}$	t _f		800		ns
	$I_F = 1.5 A$	t_{f}		500		ns

Type Dedicated Characteristics

 $T_{amb} = 25^{\circ}C$

Parameter	Test Conditions	Type	Symbol	Min	Тур	Max	Unit
Radiant Intensity	$I_F=100mA, t_p=20ms$	TSIP5200	I_{e}	20	40		mW/sr
	_	TSIP5201	I_e	30	50		mW/sr
Radiant Intensity	$I_F=1.5A$, $t_p=100\mu s$	TSIP5200	I_e	240	520		mW/sr
	•	TSIP5201	I_e	360	650		mW/sr
Radiant Power	$I_F=100mA, t_p=20ms$	TSIP5200	фе		22		mW
	•	TSIP5201	фе		25		mW



Typical Characteristics ($T_{amb} = 25^{\circ}C$ unless otherwise specified)

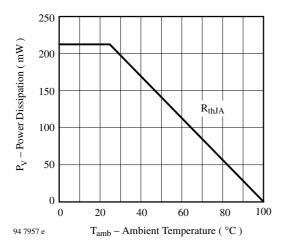


Figure 1. Power Dissipation vs. Ambient Temperature

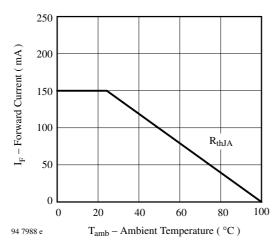


Figure 2. Forward Current vs. Ambient Temperature

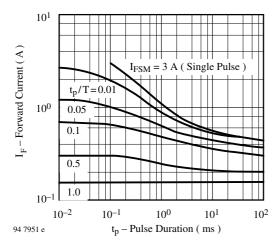


Figure 3. Pulse Forward Current vs. Pulse Duration

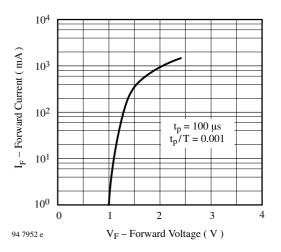


Figure 4. Forward Current vs. Forward Voltage

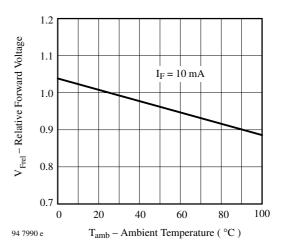


Figure 5. Relative Forward Voltage vs. Ambient Temperature

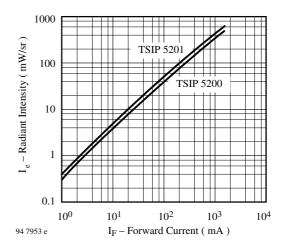


Figure 6. Radiant Intensity vs. Forward Current

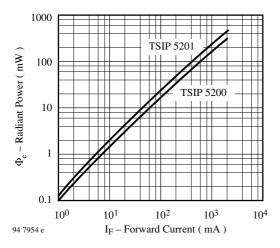


Figure 7. Radiant Power vs. Forward Current

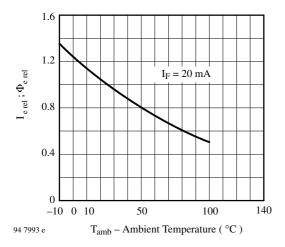


Figure 8. Rel. Radiant Intensity\Power vs. Ambient Temperature

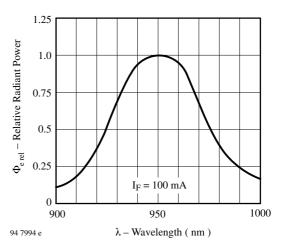


Figure 9. Relative Radiant Power vs. Wavelength

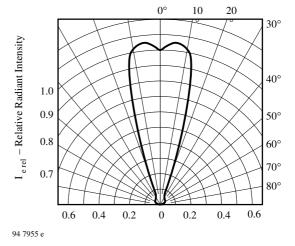
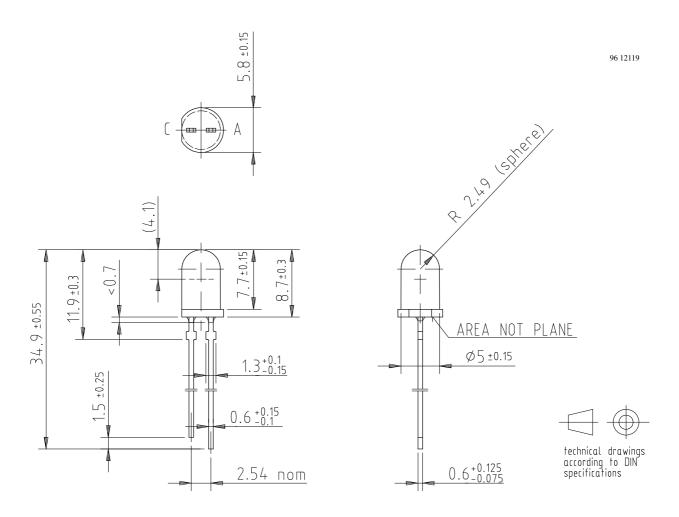


Figure 10. Relative Radiant Intensity vs. Angular Displacement



Dimensions in mm





Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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